# PXIe-4051 Specifications



# **Contents**

le-4051 Specifications 3

# PXIe-4051 Specifications

#### **Definitions**

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

**Characteristics** describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are *Warranted* unless otherwise noted.

#### **Conditions**

Specifications are valid under the following conditions unless otherwise noted.

Chassis with ≥ 58 W slot cooling capacity.



Note For more information on maximum sinking power chassis dependencies, refer to Instrument Capabilities.

- Calibration interval of 2 years.
- Warm-up time of 30 minutes.
- Self-calibration performed within the last 24 hours.
- Ambient temperature of 23 °C ± 5 °C.
- NI-DCPower Aperture Time is set to 2 power-line cycles (PLC).

#### PXIe-4051 Pinout

The following figures display the terminals on the PXIe-4051 connector.

# I/O Connections

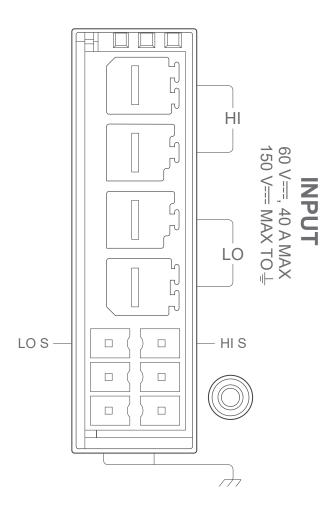


Table 1. Pin Descriptions

Pin	Description
н	The input channel terminal capable of sinking DC potential.
LO	The input channel terminal referenced to circuit common.
HI S	HI, remote voltage sense. Used to compensate for voltage measurement error due to cable voltage drops on the HI connection.
LOS	LO, remote voltage sense. Used to compensate for voltage measurement error due to cable voltage drops on the LO connection.

Pin	Description	
GND ( )	Connection to chassis (non-isolated) grounding. Used to update from a channel connection to a shield ground.	

## **AUX I/O Connectors**

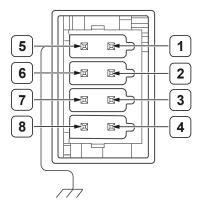


Table 2. Pin Descriptions

Pin Descriptions		Descriptions	
1	PFI 0	Dragrammable Function Interfered for digital timeing and triggering	
2	PFI 1	Programmable Function Interface for digital timing and triggering.	
3	FAULT	Device fault status output.	
4	INHIBIT	Forces the PXIe-4051 output to an inhibited state when not shorted to ground. You can short this pin to ground using the pre-installed jumper to enable normal operation.	
5	GND	Ground reference for AUX I/O.	
6	PFI 2	Programmable Function Interface for digital timing and triggering.	
7	GND	Cround reference for ALIVI/O	
8	GND	Ground reference for AUX I/O.	

# **Instrument Capabilities**

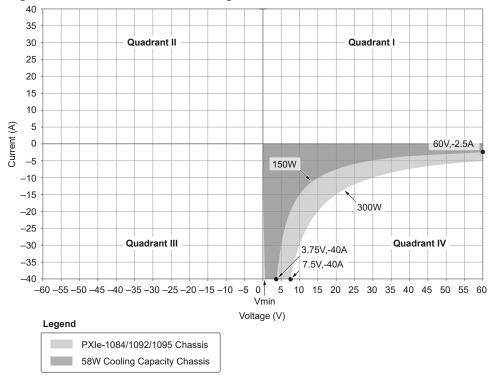
Table 3. Operational Ranges

Mode of Operation	Range
DC Voltage	6 V, 60 V

Mode of Operation	Range
DC Current	4 A, 40 A
Constant Resistance	1 kΩ
Constant Power <sup>1</sup>	150 W, 300 W

DC voltage ranges	6 V, 60 V
DC current ranges	4 A, 40 A

Figure 1. PXIe-4051 Quadrant Diagram





**Note** For more information on operation at voltages below  $V_{min}$ , refer to the following figure.

1. The Constant Power operational range of the PXIe-4051 is dependent on the cooling capacity of the chassis housing the device. Chassis with 58 W slot cooling capacities can support a constant power range of 150 W, while chassis with 82 W slot cooling capacities can support a constant power range of 300 W.

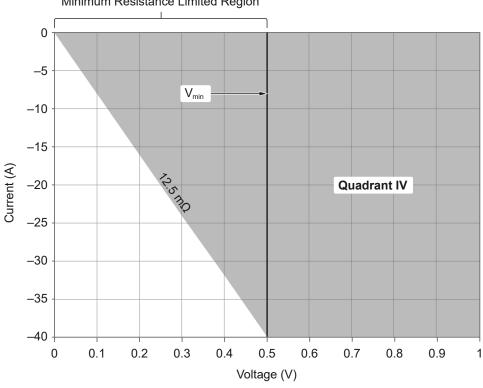


Figure 2. Expanded View of Minimum Resistance Limited Region Minimum Resistance Limited Region

Note The PXIe-4051 electronic load is a single quadrant instrument operating in quadrant IV (sink power). To match historical industry behavior of electronic loads, all other sections of the PXIe-4051 documentation and the NI-DCPower driver use a positive sign convention for current levels/limits and measurements. For code compatibility with SMU instruments, use the Instrument Mode property to determine the sign convention being used by NI-DCPower.

Table 4. Minimum Resistance Limited Region

Minimum Operating Voltage (V <sub>min</sub> )	500 mV at 40 A, typical
Minimum Force Resistance (R <sub>min</sub> )	12.5 mΩ, typical



 $oldsymbol{Note}$  Operation below  $V_{min}$  is possible when current is limited to levels

below  $V_{input}$  /  $R_{min}$ . Configuring levels outside the curve in **Figure 2** will result in a loss of regulation as the result of the power stage saturating at  $R_{min}$ .

Table 5. DC Sinking Power

Chassis Type	Max DC Sinking Power
PXIe-1084 <sup>2</sup> , PXIe-1092, PXIe-1095	300 W
58 W Slot Cooling Capacity	150 W
38 W Slot Cooling Capacity	Not Supported

## **Voltage**

Table 6. Voltage Programming and Measurement Accuracy/Resolution

Down-o-	Resolution	Noise (0.1 Hz to 10 Hz,	Accuracy ± (% of Voltage + Offset) <sup>3</sup>	Tempco <sup>4</sup> ± (% of Voltage + Offset)/°C
Range	(Noise Limited)	peak-to-peak, typical)	$T_{ambient}$ 23 °C ± 5 °C, $T_{cal}$ 5 °C	$T_{ambient}$ 0 °C to 40 °C, $T_{cal}$ ± 5 °C
6 V	1 μV	6 μV	0.03% + 600 μV	0.00050/. 1.1.1//
60 V	10 μV	60 μV	0.03% + 6 mV	0.0005% + 1 μV

- 2. The PXI Platform Services driver must be updated to version 2023 Q2 or later.
- 3. Refer to the Remote Sense section for additional accuracy derating and conditions.
- 4. Temperature coefficient applies beyond 23 °C ± 5 °C ambient within ± 5 °C of T<sub>cal</sub>.
- 5. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last self-calibration.

#### Current

Table 7. Current Programming and Measurement Accuracy/Resolution

<b>D</b>	Resolution	Noise (0.1 Hz to 10 Hz,	Accuracy ± (% of Current + Offset)	Tempco <sup>6</sup> ± (% of Current + Offset)/°C
Range	(Noise Limited)	peak-to-peak, typical)	$T_{ambient}$ 23 °C ± 5 °C, $T_{cal}^{7}$ ± 5 °C	$T_{ambient}$ 0 °C to 40 °C, $T_{cal}$ ± 5 °C
4 A	10 μΑ	60 μΑ	0.05% + 700 μΑ	0.003% + 2 μΑ
40 A	100 μΑ	350 μΑ	0.07% + 13 mA	0.0039% + 20 μΑ

### **Constant Resistance**

Table 8. Resistance Programming and Measurement Accuracy/Resolution

Range	Voltage Range	Current Range	Power Limit	Accuracy ± (% of Resistance + Offset)  T <sub>ambient</sub> 23 °C ± 5 °C, T <sub>cal</sub> <sup>8</sup> ± 5 °C
0 to 1 kΩ	60 V	40 A	300 W	0.1% + Offset <sup>9</sup>

#### **Constant Power**

Table 9. Power Programming and Measurement Accuracy/Resolution

Donas	Valta as Danas	Current Dange	Accuracy ± (% of Power + Offset)
Range	Voltage Range	Current Range	$T_{ambient}$ 23 °C ± 5 °C, $T_{cal}^{10}$ ± 5 °C
0 to 300 W	60 V	40 A	0.1% + 1 W

- 6. Temperature coefficient applies beyond 23 °C ± 5 °C ambient within ± 5 °C of T<sub>cal</sub>.
- 7. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last selfcalibration.
- 8. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last selfcalibration.
- 9. Refer to <FIGTITLE> to find the offset error based on operating conditions.
- 10. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last selfcalibration.



**Note** Use Constant Voltage mode or Constant Current mode for optimal accuracy. Constant Power mode and Constant Resistance mode are derived from both voltage and current measurements, which is a characteristic of Electronic Loads.

## Noise

The following figure illustrates measurement noise as a function of measurement aperture time for the PXIe-4051.

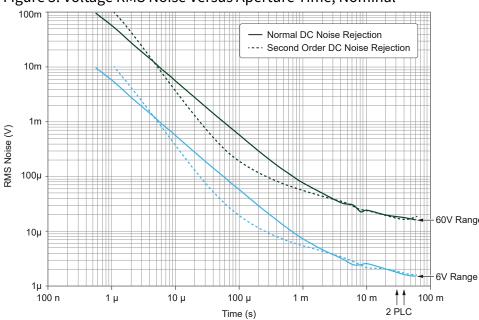


Figure 3. Voltage RMS Noise Versus Aperture Time, Nominal

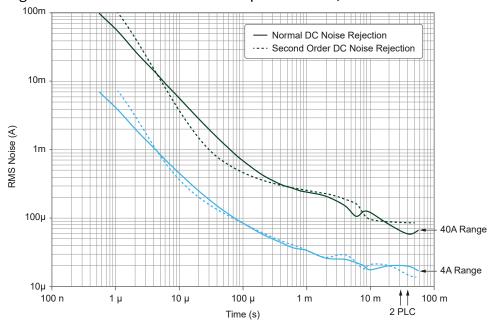


Figure 4. Current RMS Noise Versus Aperture Time, Nominal



**Note** When the aperture time is set to two power-line cycles (PLCs), measurement noise differs slightly depending on whether the Power Line Frequency property is set to 50 Hz or 60 Hz.



Note Use the DC Noise Rejection property to configure normal or secondorder DC noise rejection.

## **Inputs**

## **Programmable Conduction Voltage**

Table 10. Conduction Voltage Threshold (Von / Voff) Programming Accuracy/Resolution

Accuracy	± (6% of threshold setpoint + 50 mV), typical
Resolution	30 mV, typical



Note For more information, refer to Vload\_min, Turn-on Behavior, and Conduction Voltage Settings in the PXIe-4051 User Manual.

#### **Protection**

Channel protection	
Overtemperature	Automatic shutdown
Overpower	Automatic shutdown
Overcurrent	Automatic shutdown

## **Series and Parallel Operation**

Identically rated electronic load modules can be used in parallel in constant current modes. NI does not recommend using load modules in series.

#### **Related information:**

• <u>Vload\_min, Turn-on Behavior, and Conduction Voltage Settings</u>

## **Transient Response**

Table 11. DC Current Transient Response Performance

Transient Response Setting	Rise Time <sup>11</sup>	Slew Rate <sup>12</sup>	Setpoint Step Conditions
Slow	443 μs rise time	0.07 A/μs	
Normal	53 μs rise time	0.59 A/μs	1 A to 39 A
Fast	10 μs rise time	3 A/μs	

- 11. Measured as the time to transition from 10% to 90% of setpoint transition.
- 12. Measured as change in current divided by time between the 10% and 90% points of the setpoint transition.

Table 12. DC Voltage Transient Response Performance

Transient Response Setting	Rise Time <sup>13</sup>	Slew Rate <sup>14</sup>	Setpoint Step Conditions
Slow	26.4 ms, typical	0.001 V/μs	
Normal	1.2 ms, typical	0.033 V/μs	1 V to 50 V
Fast	103 μs, typical	0.38 V/μs	



Note These rates are typical of the SourceAdapt presets. Depending on the setup and configuration, using custom transient response can increase the slew rates beyond the performance shown. Setting a higher Gain Bandwidth than your system and setup physically allows (due to cables, inductances, capacitances, and so on.) may result in instability.

Table 13. Setpoint Slew Rate Programmable Range

NI-DCPower Property	Current Level Range	Programmable Range
Current Level Rising Slew Rate / Current Level Falling Slew Rate	4 A	10 nA/μs - 2.4 A/μs
	40 A	10 nA/μs - 24 A/μs



#### Note

- Maximum realizable slew rates are constrained by the programmed Gain Bandwidth and the limitations of the setup and system. Use programmable slew rate to obtain slower slew rates, independent rising and falling slew rates, or unique slew rates for each step in a sequence.
- If the slew rates are programmed to be slower than the sequence/step time then you will not be able to achieve the steady state programmed current or voltage within that step timing.
- Programmable Slew rates are available for Constant Current Mode only.
- 13. Measured as the time to transition from 10% to 90% of setpoint transition.
- 14. Measured as change in current divided by time between the 10% and 90% points of the setpoint transition.

• For more information, refer to *Transient Response* in the PXIe-4051 User Manual.

#### **Related information:**

• Transient Response

## **Remote Sense**

Voltage accuracy	Add 5 ppm of voltage measurement per 1 $\Omega$ of sense lead resistance if the maximum sense lead resistance specification is exceeded.
Maximum sense lead resistance	1 Ω

## **Measurement and Update Timing Characteristics**



**Note** In the following section, any references in the NI-DCPower API to a **source** actually refers to the sink functionality of the electronic load.

Available sample rates <sup>15</sup>	(1.8 MS/s)/N where N = 1, 2, 3, 2 <sup>24</sup> , nominal	
Sample rate accuracy	Equal to PXIe_CLK100 accuracy, nominal	
Maximum measure rate to host	1.8 MS/s per channel, continuous, nominal	
Maximum update rate <sup>16</sup>		

<sup>15.</sup> When sourcing while measuring, both the Source Delay and Aperture Time affect the sampling rate. When taking a measure record, only the Aperture Time affects the sampling rate.

Sequence mode	100,000 updates/s (10 μs/update), nominal	
Input trigger to		
Source event delay		10 μs, nominal
Source event jitter		4 μs peak-to-peak, nominal
Measure event jitter		2 μs peak-to-peak, nominal

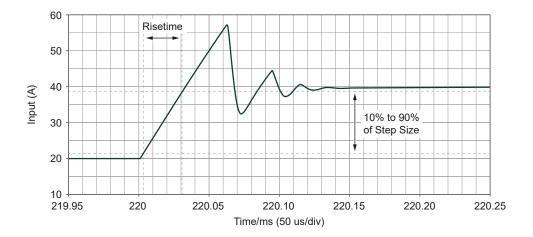
## **Using NI SourceAdapt to Optimize Transient Response**

NI SourceAdapt optimizes system transient response and interconnects for the following conditions:

- Faster slew rates
- Reduced overshoots
- Ringing

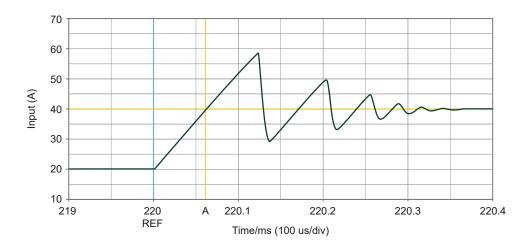
Long cables and high inductance between the DUT and the electronic load can lead to an unstable or oscillatory system. The following graph is an example of how SourceAdapt can be used to optimize a system with long cable length or high cable inductance and high required current setpoints.

16. As the Source Delay is adjusted, or if advanced sequencing is used, maximum update rates vary.



Before tuning with SourceAdapt, set the slew rate (if adjustable) to the maximum so that the slew rate limits do not mask the optimum rise times that you could possibly have with your system.

The following graph is an example of an initial transient response in a system with constant current mode and a long cable. The ringing and slew rate is limited by the inductance of the system.

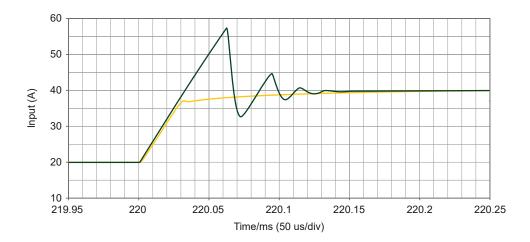


Use the Gain Bandwidth (GBW) property to decrease the bandwidth of the system until the oscillations are acceptable with no overshoots.

NI recommends using the GBW of the system inductance limited rise time from the above graph with the following formula:

$$GBW = \frac{.35}{2 * Rise Time}$$

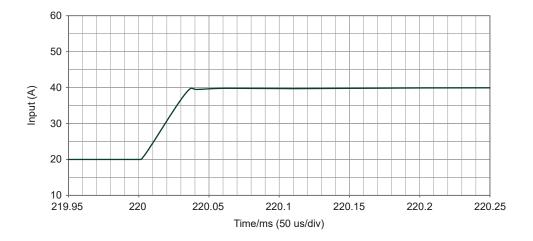
The rise time must stay within certain limits determined by the given slew rate and the resonant frequency of the system. These limits are influenced by the natural inductance of the cable. Balancing these factors is essential to ensuring the system works well and remains stable. If the system is in full oscillation, you can begin by setting a low GBW (1kHz or less) to gain stability prior to further tuning.



Tune the response by adjusting the compensation frequency and the pole-zero ratio to place additional pole and zero into the system. For example, by adjusting the compensation frequency to equal the GBW and slowly reducing the pole-zero ratio to less than unity (<1), you can optimize the step response.



Note During the tuning process, thread slowly. Overcompensation can result in overshoot and/or oscillations.



Pole frequency and zero frequency are derived by the following equations.

Pole frequency = Compensation frequency \*  $\sqrt{\text{Pole-zero ratio}}$ 

Zero frequency = 
$$\frac{\text{Compensation frequency}}{\text{Pole-zero ratio}}$$

These settings can be accessed through the Source: Transient Response set to Custom and Source: Transient Response. The Voltage or Current setting depends on the source mode in the property node.

## **Trigger Characteristics**



**Note** In the following section, any references in the NI-DCPower API to a **source** actually refers to the sink functionality of the electronic load.

Input triggers		
Types	es Start, Source, Sequence Advance, Measure	
Sources (PXI trigger lines <07>)		
Polarity		Active high (not configurable)

Minimum pulse width		100 ns, nominal
Destinations <sup>17, 18</sup> (PXI trigger lines <07>)		
Polarity Active high		not configurable)
Pulse width	>200 ns, typical	
Output triggers (events)		
Types Source Complete, Sequence Iteration Complete, Sequence Engine Done, Measure Complete		
Destinations <sup>19, 20</sup> (PXI trigger lines <07>)		
Polarity	ty Active high (not configurable)	
Pulse width >230 ns, typical		cal

## **Fault**

Connector	AUX I/O
Direction	Output

- 17. Pulse widths and logic levels are compliant with *PXI Express Hardware Specification Revision* 1.0 ECN 1.
- 18. Input triggers can be re-exported.
- 19. Pulse widths and logic levels are compliant with **PXI Express Hardware Specification Revision** 1.0 ECN 1.
- 20. Output triggers can be re-exported.

Logic type	3.3 V CMOS
Polarity	Active low (not configurable)

## Safety Voltage and Current



**Notice** The protection provided by the PXIe-4051 can be impaired if it is used in a manner not described in the user documentation.



**Warning** Take precautions to avoid electrical shock when operating this product at hazardous voltages.



**Caution** Isolation voltage ratings apply to the voltage measured between any channel pin and the chassis ground. When operating channels in series or floating on top of external voltage references, ensure that no terminal exceeds this rating.



**Attention** Les tensions nominales d'isolation s'appliquent à la tension mesurée entre n'importe quelle broche de voie et la masse du châssis. Lors de l'utilisation de voies en série ou flottantes en plus des références de tension externes, assurez-vous qu'aucun terminal ne dépasse cette valeur nominale.

DC voltage		60 V
Channel-to-earth ground isolation		
Continuous	150 VDC, CAT I	
Withstand	800 Vpk	



Caution Do not connect the PXIe-4051 to signals or use for measurements within Measurement Categories II, III, or IV.



**Attention** Ne connectez pas le PXIe-4051 à des signaux et ne l'utilisez pas pour effectuer des mesures dans les catégories de mesure II, III ou IV.

Measurement Category I is for measurements performed on circuits not directly connected to the electrical distribution system referred to as **MAINS** voltage. MAINS is a hazardous live electrical supply system that powers equipment. This category is for measurements of voltages from specially protected secondary circuits. Such voltage measurements include signal levels, special equipment, limited-energy parts of equipment, circuits powered by regulated low-voltage sources, and electronics.



Note Measurement Categories CAT I and CAT O are equivalent. These test and measurement circuits are for other circuits not intended for direct connection to the MAINS building installations of Measurement Categories CAT II, CAT III, or CAT IV.

DC current range	4 A 40 A
	40 A

## **Physical**

Dimensions	3U, three-slot, PXI Express/CompactPCI Express module 6.0 cm × 13.0 cm × 23.7 cm (2.4 in. × 5.1 in. × 9.3 in.)	
Weight		
PXIe-4051		1010 g (35.6 oz)
Front Panel Connectors		

Input Channels	OMNIMATE Hybrid, 7.62 mm (4 position), 2.54 mm (6 position)
AUX I/O	MICRO COMBICON - DFMC 0, 5, 2.54 mm (8 position)

## **Calibration Interval**

You can obtain the calibration certificate and information about calibration services for the PXIe-4051 at <u>ni.com/calibration</u>.

#### Table 14. Calibration Interval

Calibration Interval	2 years
----------------------	---------

## **Power Requirement**

PXI Express power requirement		
PXIe-4051	1 A from the 3.3 V rail and 1.7 A from the 12 V rail	

## **Environmental Characteristics**

Temperature		
Operating		0 °C to 40 °C
Storage		-40 °C to 71 °C
Humidity		
Operating	10% RH to 90% RH, noncondensing	

Storage	5% RH to 95% RH, noncondensing		
Pollution Degree		2	
Maximum Altitude		2000 m	
Shock and Vibration			
Operating Vibration 5 Hz to 500 Hz, 0.3 g RMS		RMS	
Non-Operating Vibratio	n	5 Hz to 500 Hz, 2.4 g	RMS
Operating Shock		30 g, half-sine, 11 ms	s pulse

## **Examples of Calculating Accuracy**



**Note** Specifications listed in examples are for demonstration purposes only and do not necessarily reflect specifications for this device.

# Example 1: Calculating 5 °C Accuracy

Calculate the programming / measurement accuracy of a 20 A input in the 40 A range under the following conditions:

Ambient temperature	28 °C
Internal device temperature	Within T <sub>cal</sub> <sup>21</sup> ± 5 °C
Self-calibration	Within the last 24 hours.

21. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last selfcalibration.

#### Solution

Since the device internal temperature is within  $T_{cal}^{22} \pm 5$  °C and the ambient temperature is within 23 °C  $\pm$  5 °C, the appropriate accuracy specification is:

Calculate the accuracy using the following equation:

Accuracy = 
$$20 A * 0.07 \% + 13 mA$$

= 14 mA + 13 mA

 $= 27 \, \text{mA}$ 

Therefore, the actual input will be within 27 mA of 20 A.

## **Example 2: Calculating Remote Sense Accuracy**

Calculate the remote sense accuracy of measuring 15 V in the 60 V range. Assume the same conditions as in Example 1, with the following differences:

HI sense lead resistance	5 Ω
LO sense lead resistance	1.5 Ω

#### Solution

Since the device internal temperature is within  $T_{cal}^{23} \pm 5$  °C and the ambient temperature is within 23 °C ± 5 °C, the appropriate accuracy specification is:

$$0.03\% + 6 \, \text{mV}$$

Since the device is using remote sense and the sense lead resistance exceeds the

- 22. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last self-calibration.
- 23. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last self-calibration.

maximum sense lead resistance spec, use the remote sense accuracy specification.

Add 5 ppm of voltage measurement per 1  $\Omega$  of sense lead resistance.

Calculate the remote sense accuracy using the following equation:

```
Accuracy = (15 V^* 0.03 \% + 6 \text{ mV}) + (15 V^* 5 \text{ ppm/}\Omega) * (5 \Omega + 1.5 \Omega - 1 \Omega)
= 10.5 \text{ mV} + 488 \mu\text{V}
= 10.988 mV
```

Therefore, the actual input will be within 10.988 mV of 15 V.

## **Example 3: Calculating Accuracy with Temperature** Coefficient

Calculate the accuracy of 10 A loading in the 40 A range. Assume the same conditions as in Example 1, with the following differences:

Ambient temperature	15 °C
---------------------	-------

#### Solution

Since the device internal temperature is within  $T_{cal}^{24} \pm 5$  °C, the appropriate accuracy specification is:

0.07% + 13 mA

Since the ambient temperature falls outside of 23 °C ± 5 °C, use the following temperature coefficient per degree Celsius outside the 23 °C ± 5 °C range:

 $0.0039\% + 20 \mu A$ 

Calculate the accuracy using the following equation:

24. T<sub>cal</sub> is the internal device temperature recorded by the PXIe-4051 at the completion of the last selfcalibration.

TemperatureVariation =  $(23 \degree C - 5 \degree C) - 15 \degree C = 3 \degree C$ 

Accuracy =  $(10 A * 0.07 \% + 13 mA) + (10 A * 0.0039 \% / ° C + 20 \mu A / ° C) * 3 ° C$ 

= 20 mA + 1.23 mA

= 21.23 mA

Therefore, the actual input will be within 21.23 mA of 10 A.